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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/779,658	02/18/2004	Masato Ueno	01-559	8932	
23400 7	590 10/28/2005		EXAM	EXAMINER	
POSZ LAW GROUP, PLC 12040 SOUTH LAKES DRIVE			LOUIE, WAI SING		
SUITE 101		ART UNIT	PAPER NUMBER		
RESTON, VA	20191		2814		

DATE MAILED: 10/28/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
Office Action Commence	10/779,658	UENO ET AL.			
Office Action Summary	Examiner	Art Unit			
	Wai-Sing Louie	2814			
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	TE OF THIS COMMUNICATION 6(a). In no event, however, may a reply be tim Ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI	. the mailing date of this communication. (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 15 Au	<u>igust 2005</u> .				
	- · · · · · · · · · · · · · · · · · · ·				
3) Since this application is in condition for allowan					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims					
4) Claim(s) <u>1-4</u> is/are pending in the application.					
4a) Of the above claim(s) is/are withdrawn from consideration.					
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>1-4</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9) The specification is objected to by the Examiner.					
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).					
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority under 35 U.S.C. § 119					
12)⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a)⊠ All b)□ Some * c)□ None of:					
1. Certified copies of the priority documents		on No			
 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage 					
application from the International Bureau (PCT Rule 17.2(a)).					
* See the attached detailed Office action for a list of the certified copies not received.					
Attachment(s)					
1) Notice of References Cited (PTO-892) 4) Interview Summary (PTO-413) Paper No(s)/Mail Date					
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)		Patent Application (PTO-152)			
Paper No(s)/Mail Date					

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DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-2 and 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Winterer et al. (US 6,313,729) in view of Kang (US 5,993,735) and Chen et al. (US 6,765,277).

With regard to claim 1, Winterer et al. disclose semiconductor device (col. 3, line 38 to col. 5, line 67 and fig. 1) comprising:

- a conductive member 7 (fig. 1);
- a sensor chip 6 for detecting a pressure and generating an electrical signal corresponding to the pressure (col. 4, lines 51-61 and fig. 1);
- a bonding wire 21 electrically connecting the sensor chip 6 and the conductive member 7 (fig. 1);
- a protective member 32 having characteristics of electric insulation and plasticity
 and covering the sensor chip 6 and bonding wire 21 (col. 5, lines 40-61 and fig.
 1);
- Winterer et al. show a bonding pad provided on a surface the sensor chip 6 (fig.
 1), but do not disclose the bonding pad is formed of aluminum base material.
 However, Chen et al. disclose a bonding pad 15 formed on a surface of a

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microelectronic chip 10 (Chen col. 3, lines 26-34 and fig. 5). Chen et al. teach the bonding pads are often corroded that would degrade the bonding pads. Therefore, it would have been obvious to one of ordinary skill in the art to modify Winterer's device with the teaching of Chen et al. to provide an aluminum bonding pad in order to prevent corrosion of the bonding pad;

• Winterer et al. do not disclose the bonding wire is formed of an alloy of Au and Pd. However, Kang disclose the bonding wire is formed of an alloy of Au and Photodiode (Kang Table 1). Kang teaches the addition of Pd which causes the tensile strength to be increased and make it possible to prevent bending or curving after bonding (Kang col. 2, lines 37-42). Hence, it would have been obvious at the time the invention was made to modify Winterer's device with the teaching of Kang to form of an alloy of Au and Pd in order to increase in tensile strength and make it possible to prevent bending or curving after bonding.

With regard to claims 2 and 4, Winterer et al. modified by Kang disclose the diameter of bonding wire is 33 um (Kang col. 3, line 34).

Claim 3 is rejected under 35 U.S.C. 103(a) as being unpatentable over Winterer et al. (US 6,313,729) modified by Kang (US 5,993,735) and Chen et al. (US 6,765,277) as applied to claim 1 above, and further in view of Mizuno (US 5,101,665).

With regard to claim 3, in addition to the limitations disclosed in claim 1, Winterer et al. modified by Kang and Chen et al. also disclose:

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• Winterer et al. modified by Kang and Chen et al. do not disclose a circuit chip for processing the electrical signal from the sensor chip and an additional bonding wire electrically connecting the circuit chip. However, Mizuno discloses an IC chip 11 in the pressure sensor chip package 15 connected with bond wire 21 (Mizuno fig. 3). Mizuno teaches the IC chip is for communicating to a circuit outside of the semiconductor pressure sensor (Mizuno col. 3, lines 18-24). Thus, it would have been obvious for one with skilled in the art to modify Winterer's device with the teaching of Kang, Chen et al., and Mizuno to provide an IC chip in the pressure sensor package in order to communicate to the outside circuit.

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Response to Arguments

Applicant's arguments filed 8/15/05 have been fully considered but they are not persuasive.

Applicant argues that Winterer et al. do not disclose a bonding pad that is formed
of an aluminum base material. However, Winterer et al. modified by Chen et al.
would disclose the above feature. Please see the rejection above.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Wai-Sing Louie whose telephone number is (571) 272-1709. The examiner can normally be reached on 7:30 AM to 4:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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October 21, 2005.

PRIMÁRY EXA